

# Exhibit 12



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**Leedy**

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(54) **THREE DIMENSIONAL STRUCTURE MEMORY**

(56) **References Cited**

U.S. PATENT DOCUMENTS

(71) Applicant: **Glenn J Leedy**, Carmel, CA (US)  
(72) Inventor: **Glenn J Leedy**, Carmel, CA (US)  
(\* ) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 0 days.  
  
This patent is subject to a terminal disclaimer.

2,915,722	A	12/1959	Foster
3,202,948	A	8/1965	Farrand
3,430,835	A	3/1969	Patzer et al.
3,559,282	A	2/1971	Lesk
3,560,364	A	2/1971	Burkhardt
3,602,982	A	9/1971	Kooi
3,615,901	A	10/1971	Medicus
3,636,358	A	1/1972	Groschwitz

(Continued)

FOREIGN PATENT DOCUMENTS

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OTHER PUBLICATIONS

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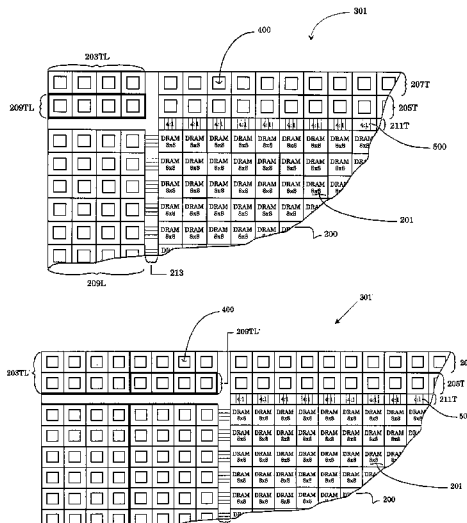
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(57) **ABSTRACT**

A Three-Dimensional Structure (3DS) Memory allows for physical separation of the memory circuits and the control logic circuit onto different layers such that each layer may be separately optimized. One control logic circuit suffices for several memory circuits, reducing cost. Fabrication of 3DS memory involves thinning of the memory circuit to less than 50 microns in thickness and bonding the circuit to a circuit stack while still in wafer substrate form. Fine-grain high density inter-layer vertical bus connections are used. The 3DS memory manufacturing method enables several performance and physical size efficiencies, and is implemented with established semiconductor processing techniques.

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(58) **Field of Classification Search**  
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See application file for complete search history.

**161 Claims, 9 Drawing Sheets**



US 8,791,581 B2

(56)

References Cited

U.S. PATENT DOCUMENTS

3,716,429 A	2/1973	Napoli et al.	4,994,336 A	2/1991	Benecke et al.
3,777,227 A	12/1973	Krishna et al.	4,994,735 A	2/1991	Leedy
3,780,352 A	12/1973	Redwanz	5,000,113 A	3/1991	Wang et al.
3,868,565 A	2/1975	Kuipers	5,008,619 A	4/1991	Keogh et al.
3,922,705 A	11/1975	Yerman	5,010,024 A	4/1991	Allen et al.
3,932,932 A	1/1976	Goodman	5,020,219 A	6/1991	Leedy
3,997,381 A	12/1976	Wanlass	5,051,326 A	9/1991	Celler et al.
4,028,547 A	6/1977	Eisenberger	5,059,556 A	10/1991	Wilcoxon
4,070,230 A	1/1978	Stein	5,062,689 A	11/1991	Koehler
4,089,063 A	5/1978	Takezono et al.	5,064,275 A	11/1991	Tsunoda et al.
4,131,985 A	1/1979	Greenwood et al.	5,070,026 A	12/1991	Greenwald et al.
4,142,004 A	2/1979	Hauser, Jr. et al.	5,071,510 A	12/1991	Findler et al.
4,196,232 A	4/1980	Schnable et al.	5,087,585 A	2/1992	Hayashi
4,246,595 A	1/1981	Noyori et al.	5,098,865 A	3/1992	Machado et al.
4,249,302 A	2/1981	Crepeau	5,103,557 A	4/1992	Leedy
4,251,909 A	2/1981	Hoeberechts	5,109,360 A	4/1992	Inazumi et al.
4,262,631 A	4/1981	Kubacki	5,110,373 A	5/1992	Mauger
4,393,127 A	7/1983	Greschner et al.	5,110,712 A	5/1992	Kessler et al.
4,394,401 A	7/1983	Shioya et al.	5,111,278 A	5/1992	Eichelberger
4,401,986 A	8/1983	Trenkler et al.	5,116,777 A	5/1992	Chan et al.
4,416,054 A	11/1983	Thomas et al.	5,117,282 A	5/1992	Salatino
4,464,747 A	8/1984	Groudau et al.	5,119,164 A	6/1992	Sliwa et al.
4,500,905 A	2/1985	Shibata	5,130,894 A	7/1992	Miller
4,528,072 A	7/1985	Kurosawa et al.	5,132,244 A	7/1992	Roy
4,539,068 A	9/1985	Takagi et al.	5,144,142 A	9/1992	Fueki et al.
4,566,037 A	1/1986	Takatsu et al.	5,151,775 A	9/1992	Hadwin
4,585,991 A	4/1986	Reid et al.	5,156,909 A	10/1992	Henager, Jr. et al.
4,604,162 A	8/1986	Sobczak	5,166,962 A	11/1992	Murooka et al.
4,612,083 A	9/1986	Yasumoto et al.	5,169,805 A	12/1992	Mok et al.
4,617,160 A	10/1986	Belanger et al.	5,188,706 A	2/1993	Hori et al.
4,618,397 A	10/1986	Shimizu et al.	5,198,965 A	3/1993	Curtis et al.
4,618,763 A	10/1986	Schmitz	5,202,754 A	4/1993	Bertin et al.
4,622,632 A	11/1986	Tanimoto et al.	5,203,731 A	4/1993	Zimmerman
4,633,438 A *	12/1986	Kume et al. .... 365/51	5,225,771 A	7/1993	Leedy
4,642,487 A	2/1987	Carter	5,236,118 A	8/1993	Bower et al.
4,663,559 A	5/1987	Christensen	5,240,458 A	8/1993	Linglain et al.
4,684,436 A	8/1987	Burns et al.	5,241,454 A	8/1993	Ameen et al.
4,693,770 A	9/1987	Hatada	5,245,227 A	9/1993	Furtek et al.
4,702,336 A	10/1987	Seibert et al.	5,245,277 A	9/1993	Nguyen
4,702,936 A	10/1987	Maeda et al.	5,255,227 A	10/1993	Haefele
4,706,166 A	11/1987	Go	5,259,247 A	11/1993	Bantien
4,721,938 A	1/1988	Stevenson	5,262,341 A	11/1993	Fueki et al.
4,724,328 A	2/1988	Lischke	5,262,351 A	11/1993	Bureau et al.
4,761,681 A	8/1988	Reid	5,270,261 A	12/1993	Bertin et al.
4,766,670 A	8/1988	Gazdik et al.	5,273,940 A	12/1993	Sanders
4,784,721 A	11/1988	Holmen et al.	5,274,270 A	12/1993	Tuckerman
4,810,673 A	3/1989	Freeman	5,279,865 A	1/1994	Chebi et al.
4,810,889 A	3/1989	Yokomatsu et al.	5,283,107 A	2/1994	Bayer et al.
4,825,277 A	4/1989	Mattox et al.	5,284,796 A	2/1994	Nakanishi et al.
4,835,765 A	5/1989	Bergmans et al.	5,284,804 A	2/1994	Moslehi
4,849,857 A	7/1989	Butt et al.	5,293,457 A	3/1994	Arima et al.
4,855,867 A	8/1989	Gazdik et al.	5,321,884 A	6/1994	Ameen et al.
4,857,481 A	8/1989	Tam et al.	5,323,035 A	6/1994	Leedy
4,890,157 A	12/1989	Wilson	5,323,060 A	6/1994	Fogal et al.
4,892,753 A	1/1990	Wang et al.	5,324,687 A	6/1994	Wojnarowski
4,892,842 A	1/1990	Corrie et al.	5,343,366 A	8/1994	Cipolla et al.
4,897,708 A	1/1990	Clements	5,343,406 A	8/1994	Freeman
4,919,749 A	4/1990	Mauger et al.	5,347,428 A	9/1994	Carson et al.
4,924,589 A	5/1990	Leedy	5,354,695 A	10/1994	Leedy
4,928,058 A	5/1990	Williamson	5,357,473 A	10/1994	Mizuno
2,641,129 A	6/1990	Bull	5,358,909 A	10/1994	Hashiguchi et al.
4,934,799 A	6/1990	Chu	5,363,021 A	11/1994	MacDonald
4,939,568 A	7/1990	Kato et al.	5,374,564 A	12/1994	Bruel
4,939,694 A	7/1990	Eaton et al.	5,374,920 A	12/1994	Evens
4,940,916 A	7/1990	Borel et al.	5,374,940 A	12/1994	Corio
4,950,987 A	8/1990	Vranish et al.	5,385,632 A	1/1995	Goossen
4,952,446 A	8/1990	Lee et al.	5,385,909 A	1/1995	Nelson et al.
4,954,865 A	9/1990	Rokos	5,397,747 A	3/1995	Angiulli et al.
4,954,875 A	9/1990	Clements	5,399,505 A	3/1995	Dasse et al.
4,957,882 A	9/1990	Shinomiya	RE34,893 E	4/1995	Fujii et al.
4,965,415 A	10/1990	Young et al.	5,420,458 A	5/1995	Shimoji
4,966,663 A	10/1990	Mauger	5,424,920 A	6/1995	Miyake
4,983,251 A	1/1991	Haisma et al.	5,426,072 A	6/1995	Finnila
			5,426,363 A	6/1995	Akagi et al.
			5,426,378 A	6/1995	Ong
			5,432,444 A	7/1995	Yasohama et al.
			5,432,681 A	7/1995	Linderman

**US 8,791,581 B2**

Page 3

(56)

**References Cited**

U.S. PATENT DOCUMENTS

			5,834,162 A	11/1998	Malba
			5,834,334 A	11/1998	Leedy
			5,840,593 A	11/1998	Leedy
			5,847,929 A	12/1998	Bernier et al.
5,432,999 A	7/1995	Capps et al.	5,856,695 A	1/1999	Ito et al.
5,434,500 A	7/1995	Hauck et al.	5,861,761 A	1/1999	Kean
5,448,106 A	9/1995	Fujitsu	5,868,949 A	2/1999	Sotokawa et al.
5,450,603 A	9/1995	Davies	5,869,354 A	2/1999	Leedy
5,451,489 A	9/1995	Leedy	5,870,176 A	2/1999	Sweatt et al.
5,457,879 A	10/1995	Gurtler et al.	5,880,010 A	3/1999	Davidson
5,463,246 A	10/1995	Matsunami	5,882,532 A	3/1999	Field et al.
5,468,606 A	11/1995	Bogart et al.	5,892,271 A	4/1999	Takeda et al.
5,470,693 A	11/1995	Sachdev et al.	5,902,118 A	5/1999	Hubner
5,476,813 A	12/1995	Naruse	5,907,248 A	5/1999	Bauer
5,478,781 A	12/1995	Bertin et al.	5,914,504 A	6/1999	Augusto
5,480,842 A	1/1996	Clifton et al.	5,915,167 A	6/1999	Leedy
5,481,133 A	1/1996	Hsu	5,930,150 A	7/1999	Cohen et al.
5,489,554 A	2/1996	Gates	5,940,031 A	8/1999	Turlington et al.
5,502,667 A	3/1996	Bertin et al.	5,946,559 A	8/1999	Leedy
5,512,397 A	4/1996	Leedy	5,976,953 A	11/1999	Zavracky et al.
5,514,628 A	5/1996	Enomoto et al.	5,985,693 A	11/1999	Leedy
5,517,457 A	5/1996	Sakui et al.	5,998,069 A	12/1999	Cutter et al.
5,527,645 A	6/1996	Pati et al.	6,002,268 A	12/1999	Sasaki
5,529,829 A	6/1996	Koskenmaki et al.	6,008,126 A	12/1999	Leedy
5,534,465 A	7/1996	Frye et al.	6,008,530 A	12/1999	Kano
5,552,995 A	9/1996	Sebastian	6,017,658 A	1/2000	Rhee et al.
5,555,212 A	9/1996	Toshiaki et al.	6,020,257 A	2/2000	Leedy
5,563,084 A	10/1996	Ramm et al.	6,023,098 A	2/2000	Higashiguchi et al.
5,571,741 A	11/1996	Leedy	6,027,958 A	2/2000	Vu et al.
5,572,689 A	11/1996	Gallup et al.	RE36,623 E	3/2000	Wang et al.
5,574,729 A	11/1996	Kinoshita et al.	6,045,625 A	4/2000	Houston
5,577,050 A	11/1996	Bair et al.	6,050,832 A	4/2000	Lee et al.
5,580,687 A	12/1996	Leedy	6,084,284 A	7/2000	Adamic, Jr.
5,581,498 A	12/1996	Ludwig et al.	6,087,284 A	7/2000	Brix et al.
5,582,939 A	12/1996	Pierrat	6,092,174 A	7/2000	Roussakov
5,583,688 A	12/1996	Hornbeck	6,097,096 A	8/2000	Gardner et al.
5,583,749 A	12/1996	Tredennick	6,133,626 A	10/2000	Hawke et al.
5,592,007 A	1/1997	Leedy	6,133,640 A	10/2000	Leedy
5,592,018 A	1/1997	Leedy	6,154,809 A	11/2000	Ikenaga et al.
5,595,933 A	1/1997	Heijboer	6,166,559 A	12/2000	McClintock et al.
5,606,186 A	2/1997	Noda	6,166,711 A	12/2000	Odake
5,615,163 A	3/1997	Sakui et al.	6,194,245 B1	2/2001	Tayanaka
5,620,915 A	4/1997	Chen et al.	6,197,456 B1	3/2001	Aleshin et al.
5,626,137 A	5/1997	Dumoulin et al.	6,208,545 B1	3/2001	Leedy
5,627,112 A	5/1997	Tennant et al.	6,230,233 B1	5/2001	Lofgren et al.
5,629,137 A	5/1997	Leedy	6,236,602 B1	5/2001	Patti
5,633,209 A	5/1997	Leedy	6,239,495 B1	5/2001	Sakui et al.
5,637,536 A	6/1997	Val	6,261,728 B1	7/2001	Lin
5,637,907 A	6/1997	Leedy	6,288,561 B1	9/2001	Leedy
5,654,127 A	8/1997	Leedy	6,294,909 B1	9/2001	Leedy
5,654,220 A	8/1997	Leedy	6,300,935 B1	10/2001	Sobel et al.
5,656,552 A	8/1997	Hudak et al.	6,301,653 B1	10/2001	Mohamed et al.
5,661,339 A	8/1997	Clayton	6,320,593 B1	11/2001	Sobel et al.
5,666,288 A	9/1997	Jones et al.	6,335,491 B1	1/2002	Alagaratnam et al.
5,675,185 A	10/1997	Chen et al.	6,355,976 B1	3/2002	Faris
5,691,945 A	11/1997	Liou et al.	RE37,637 E	4/2002	Clifton et al.
5,694,588 A	12/1997	Ohara et al.	6,376,909 B1	4/2002	Forbes et al.
5,715,144 A	2/1998	Ameen et al.	6,392,304 B1	5/2002	Butler
5,719,438 A	2/1998	Beilstein et al.	6,417,027 B1	7/2002	Akram
5,725,995 A	3/1998	Leedy	6,445,006 B1	9/2002	Brandes et al.
5,733,814 A	3/1998	Flesher et al.	6,511,857 B1	1/2003	Kono et al.
5,736,448 A	4/1998	Saia et al.	6,518,073 B2	2/2003	Momohara
5,745,076 A	4/1998	Turlington et al.	6,551,857 B2	4/2003	Leedy
5,745,673 A	4/1998	Di Zenzo et al.	6,563,224 B2	5/2003	Leedy
5,750,211 A	5/1998	Weise et al.	6,617,671 B1	9/2003	Akram
5,753,536 A	5/1998	Sugiyama et al.	6,632,706 B1	10/2003	Leedy
5,760,478 A	6/1998	Bozso et al.	6,682,981 B2	1/2004	Leedy
5,763,943 A	6/1998	Baker et al.	6,707,160 B2	3/2004	Yamaji
5,764,577 A	6/1998	Johnston et al.	6,713,327 B2	3/2004	Leedy
5,764,878 A	6/1998	Kablanian et al.	6,714,625 B1	3/2004	Leedy
5,773,152 A	6/1998	Okonogi	6,740,964 B2	5/2004	Sasaki
5,777,379 A	7/1998	Karavakis et al.	6,747,347 B2	6/2004	Farrar et al.
5,786,116 A	7/1998	Rolfson	6,765,279 B2	7/2004	Leedy
5,786,628 A	7/1998	Beilstein et al.	6,838,896 B2	1/2005	Leedy
5,786,629 A	7/1998	Faris	6,867,486 B2	3/2005	Hong
5,787,445 A	7/1998	Daberko	6,891,387 B2	5/2005	Leedy
5,793,115 A	8/1998	Zavracky et al.	6,894,392 B1	5/2005	Gudesen et al.

**US 8,791,581 B2**

Page 4

(56)

**References Cited**

U.S. PATENT DOCUMENTS

7,176,545 B2	2/2007	Leedy	2003/0223535 A1	12/2003	Leedy
7,176,579 B2	2/2007	Konishi et al.	2004/0000708 A1	1/2004	Rapport et al.
7,193,239 B2	3/2007	Leedy	2004/0021212 A1	2/2004	Hamaguchi et al.
7,223,696 B2	5/2007	Leedy	2004/0070063 A1	4/2004	Leedy
7,230,316 B2	6/2007	Yamazaki et al.	2004/0140547 A1	7/2004	Yamazaki et al.
7,242,012 B2	7/2007	Leedy	2004/0197951 A1	10/2004	Leedy
7,307,020 B2	12/2007	Leedy	2004/0245617 A1	12/2004	Damberg et al.
7,354,798 B2	4/2008	Pogge et al.	2005/0023656 A1	2/2005	Leedy
7,385,835 B2	6/2008	Leedy	2005/0051841 A1	3/2005	Leedy
7,402,897 B2	7/2008	Leedy	2005/0082641 A1	4/2005	Leedy
7,474,004 B2	1/2009	Leedy	2006/0231927 A1	10/2006	Ohno
7,479,694 B2	1/2009	Leedy	2007/0035033 A1	2/2007	Ozguz et al.
7,485,571 B2	2/2009	Leedy	2007/0176297 A1	8/2007	Zohni
7,485,955 B2	2/2009	Kang et al.	2008/0237591 A1	10/2008	Leedy
7,489,025 B2	2/2009	Chen et al.	2008/0254572 A1	10/2008	Leedy
7,504,732 B2	3/2009	Leedy	2008/0284611 A1	11/2008	Leedy
7,521,785 B2	4/2009	Damberg et al.	2008/0302559 A1	12/2008	Leedy
7,550,805 B2	6/2009	Leedy	2009/0014897 A1	1/2009	Ohno
7,615,837 B2	11/2009	Leedy	2009/0067210 A1	3/2009	Leedy
7,670,893 B2	3/2010	Leedy	2009/0174082 A1	7/2009	Leedy
7,705,466 B2	4/2010	Leedy	2009/0175104 A1	7/2009	Leedy
7,736,948 B2	6/2010	Dekker et al.	2009/0194768 A1	8/2009	Leedy
7,763,948 B2	7/2010	Leedy	2009/0218700 A1	9/2009	Leedy
7,820,469 B2	10/2010	Leedy	2009/0219742 A1	9/2009	Leedy
7,911,012 B2	3/2011	Leedy	2009/0219743 A1	9/2009	Leedy
8,080,442 B2	12/2011	Leedy	2009/0219744 A1	9/2009	Leedy
8,410,617 B2	4/2013	Leedy	2009/0219772 A1	9/2009	Leedy
2001/0002711 A1	6/2001	Gonzalez	2009/0230501 A1	9/2009	Leedy
2001/0014051 A1	8/2001	Watanabe et al.	2010/0148371 A1	6/2010	Kaskoun et al.
2001/0025364 A1	9/2001	Kaneko	2010/0171224 A1	7/2010	Leedy
2001/0033030 A1	10/2001	Leedy	2010/0171225 A1	7/2010	Leedy
2002/0117689 A1	8/2002	Akimoto	2010/0172197 A1	7/2010	Leedy
2002/0127775 A1	9/2002	Haba et al.	2010/0173453 A1	7/2010	Leedy
2002/0132465 A1	9/2002	Leedy	2011/0042829 A1	2/2011	Kaskoun et al.
2003/0011032 A1	1/2003	Umebayashi	2011/0198672 A1*	8/2011	Leedy ..... 257/211
2003/0173608 A1	9/2003	Leedy			
2003/0184976 A1	10/2003	Brandenburg et al.			
2003/0197253 A1	10/2003	Gann et al.			
2003/0218182 A1	11/2003	Leedy			

OTHER PUBLICATIONS

Bollmann et al., Three Dimensional Metallization for Vertically Integrated Circuits, Materials for Advanced Metallization, 1997, European Workshop; Date of Conference: Mar. 16-19, 1997.

\* cited by examiner

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